

FINAL PRODUCT/PROCESS CHANGE NOTIFICATION

11 May 2009

SUBJECT: ON Semiconductor Final Product/Process Change Notification #16253

TITLE: Final Notification for Transfer of High Voltage Zener and Zener TVS (Transient Voltage Suppressor) Products from ON Semiconductor ZR Fab in Phoenix (USA) to ON Semiconductor ISMF Fab in Seremban (Malaysia).

PROPOSED FIRST SHIP DATE: 10 Aug 2009

AFFECTED CHANGE CATEGORY(S): ON Semiconductor Fab Sites

AFFECTED PRODUCT DIVISION(S): Protection & Control Business Unit

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or Yew Hee Soon < <u>y.soon@onsemi.com</u> >

SAMPLES: Contact your local ON Semiconductor Sales Office

ADDITIONAL RELIABILITY DATA: Available

Contact your local ON Semiconductor Sales Office or Laura Rivers < laura.rivers@onsemi.com >

NOTIFICATION TYPE:

Final Product/Process Change Notification (FPCN)

Final change notification sent to customers. FPCNs are issued at least 90 days prior to implementation of the change.

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

DESCRIPTION AND PURPOSE:

ON Semiconductor is notifying customers of its plan to transfer High Voltage Zener and Zener TVS products from ON Semiconductor ZR Fab in Phoenix (USA) to ON Semiconductor ISMF Fab in Seremban (Malaysia). This PCN covers the Zener voltage range from 100 V to 200V.

This ISMF Facility is an ON Semiconductor owned wafer fab that has been producing products for ON Semiconductor since 1998. Several existing technologies within ON Semiconductor's product families are currently sourced from ISMF, including Zener, Diodes, Small Signal, and USB array filter products. ON Semiconductor Seremban Wafer FA is an internal factory that is TS16949, ISO-9001 and ISO-14000 certified.

Qualification tests are designed to show that the reliability of transferred devices will continue to meet or exceed ON Semiconductor standards.

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Devices listed in this final PCN will transfer to ON Semiconductor ISMF Fab in Seremban (Malaysia) starting 04 Aug 2009. After 04 Aug 2009, customers may receive devices from either facility.

RELIABILITY DATA SUMMARY:

Reliability Test Results:

200V Zener TVS:

P6SMB200AT3G

Control and Qual.

Test	Conditions		Results
HTRB MSL 1	Ta=150c, Vr=80% rated V 3X IR @ 260C	1008 hrs	0/252 0/1008*
IOL +PC	Ta=25C, delta Tj max=100C		0/1000
	Ton=Toff=2min	15000 cyc	0/252
H3TRB+PC	Ta=85C, RH=85%, Vr=100V	1008 hrs	0/252
Autoclave +PC	Ta=121C, RH=100% psig~15	96 hrs	0/252
Temp Cycle+PC	Ta=-65/150C	1000 cyc	0/252
HTSL	Ta=150C	1000 hrs	0/252
DPA TC	AEC Q101		0/6
DPA H3TRB	AEC Q101		0/6

^{*} MSL 1 @ 260C preconditioning prior to IOL, TC, AC and H3TRB

ELECTRICAL CHARACTERISTIC SUMMARY:

Available upon request

CHANGED PART IDENTIFICATION:

Devices from On Semiconductor with date code 0931 (or 931 or 8) and greater may be sourced from either the ISMF Fab in Seremban (Malaysia) or the ZR Fab in Phoenix (USA).

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AFFECTED DEVICE LIST

- 1N5378BG
- 1N5378BRLG
- 1N5380BG
- 1N5380BRLG
- 1N5381BRLG
- 1N5383BG
- 1N5383BRLG
- 1N5384BG
- 1N5384BRLG
- 1N5386BG
- 1N5386BRLG
- 1N5387BRLG
- 1N5388BG
- 1N5388BRLG
- 1N5952BRLG
- 1N5953BG
- 1N5953BRLG
- 1N5955BRLG
- 1N5956BG
- 1N5956BRLG
- 1N6295AG
- 1SMB100AT3G
- 1SMB110AT3G
- 1SMB110AT3G
- 1SMB120AT3G
- 1SMB120AT3G
- 1SMB130AT3G
- 1SMB130AT3G
- 1SMB150AT3G
- 1SMB150AT3G
- 1SMB160AT3G
- 1SMB160AT3G 1SMB170AT3G
- 1SMB170AT3G
- 1SMB5949BT3G
- 1SMB5951BT3G
- 1SMB5952BT3G
- 1SMB5953BT3G
- 1SMB5954BT3G
- 1SMB5955BT3G
- 1SMB5956BT3G
- 1SMB85AT3G
- 1SMB90AT3G
- BZG03C150G
- MMSZ5272BT3G
- P6KE100ARLG
- P6KE120ARLG
- P6KE130AG
- P6KE150AG
- P6KE150AG
- P6KE150ARLG
- P6KE150ARLG

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P6KE160ARLG

P6KE160ARLG

P6KE180ARLG

P6KE180ARLG

P6KE200AG

P6KE200AG

P6KE200ARLG

P6KE200ARLG

P6KE200BRLG

P6KE200BRLG

P6SMB100AT3G

P6SMB120AT3G

P6SMB130AT3G

P6SMB150AT3G

P6SMB150AT3G

P6SMB160AT3

P6SMB160AT3

P6SMB160AT3G

P6SMB160AT3G

P6SMB180AT3G

P6SMB180AT3G

P6SMB200AT3

P6SMB200AT3

P6SMB200AT3G

P6SMB200AT3G

S1ZP6SMB150AT3

S1ZP6SMB150AT3

SA100AG

SA170ARLG

SA170ARLG

SZ1SMB5952BT3

SZ1SMB5953BT3

SZ1SMB5956BT3G

SZ2888BT3G

SZP6SMB200AT3G

SZP6SMB200AT3G

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